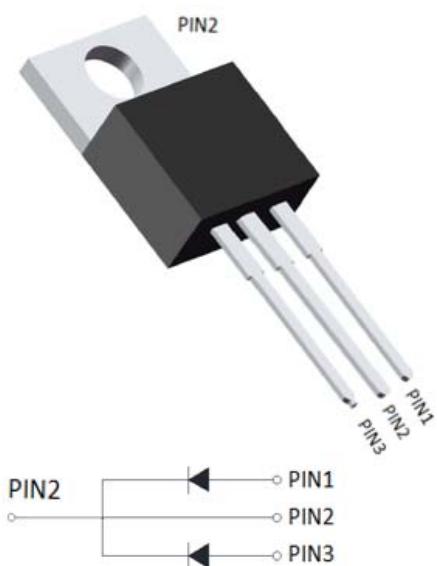




## Schottky Diodes



### Features

- High frequency operation
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Solder dip 275 °C max. 7 s, per JESD 22-B106

### Typical Applications

Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

### Mechanical Data

- **Package:** TO-220AB  
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** As marked

### ■Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER		SYMBOL	UNIT	MBR40150CT
Device marking code				MBR40150CT
Repetitive Peak Reverse Voltage		V <sub>RRM</sub>	V	150
Average Rectified Output Current @60Hz sine wave, R-load, Tc=107°C		I <sub>o</sub>	A	40
Surge(Non-repetitive)Forward Current @60Hz half sine-wave, 1 cycle, Ta=25°C		I <sub>FSM</sub>	A	300
Surge(Non-repetitive)Forward Current @1ms, square wave, 1 time, Ta=25°C				600
Current Squared Time @1ms≤t≤8.3ms Tj=25°C,		I <sup>2</sup> t	A <sup>2</sup> s	373
Typical junction capacitance	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C.	C <sub>j</sub>	pF	410
Storage Temperature		T <sub>stg</sub>	°C	-55 ~ +175
Junction Temperature		T <sub>j</sub>	°C	-55 ~ +175

### ■Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	Min	Typ	Max
Peak Forward Voltage	V <sub>FM</sub>	V	I <sub>FM</sub> =20.0A Ta=25°C	0.5	0.815	0.85
			I <sub>FM</sub> =20.0A Ta=125°C	-	0.68	0.72
Maximum DC reverse current at rated DC blocking voltage per diode	I <sub>RRM1</sub>	mA	V <sub>RM</sub> =V <sub>RRM</sub> Tj=25°C	-	-	0.1
	I <sub>RRM2</sub>		V <sub>RM</sub> =V <sub>RRM</sub> Tj=125°C	-	-	20

Note1:Pulse test:300uS pulse width,1% duty cycle

Note2:Pulse test:pulse width 40mS



■ **Thermal Characteristics** ( $T_a=25^\circ\text{C}$  Unless otherwise specified)

PARAMETER		SYMBOL	UNIT	MBR40150CT
Thermal Resistance	Between junction and ambient	$R_{\theta J-A}$	$^\circ\text{C/W}$	50.0
	Between junction and case	$R_{\theta J-C}$	$^\circ\text{C/W}$	2.0

■ **Characteristics (Typical)**

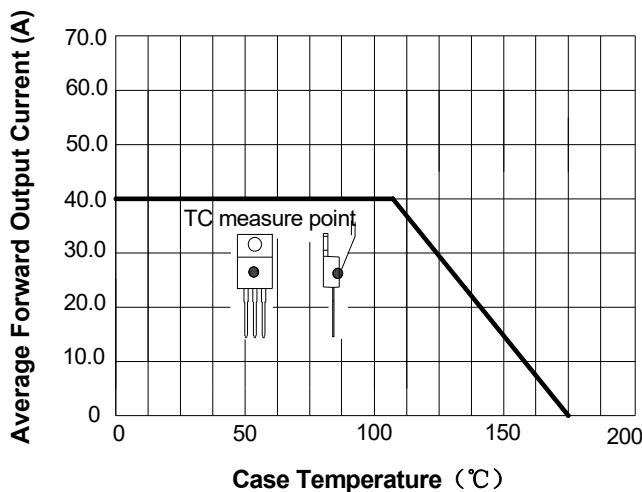
FIG1:  $i_o - T_c$  Curve

FIG2: Surge Forward Current Capability

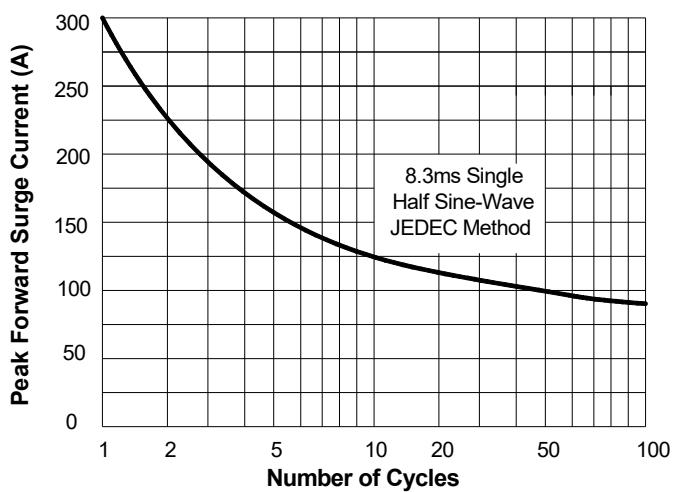


FIG3: Forward Voltage

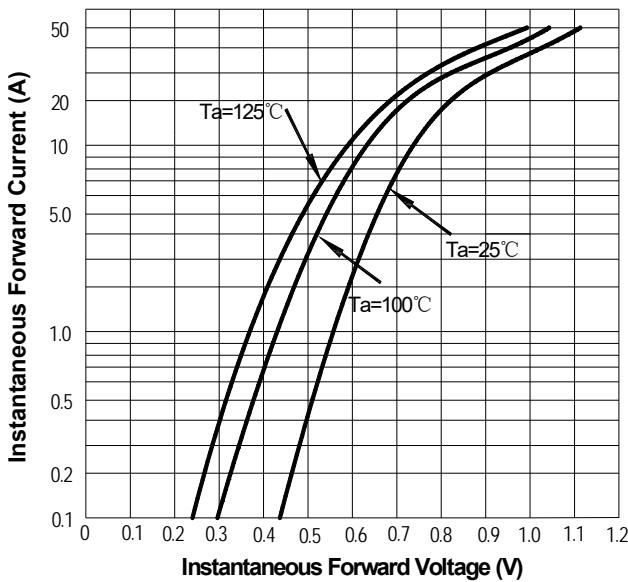


FIG4: Instantaneous Reverse Characteristics

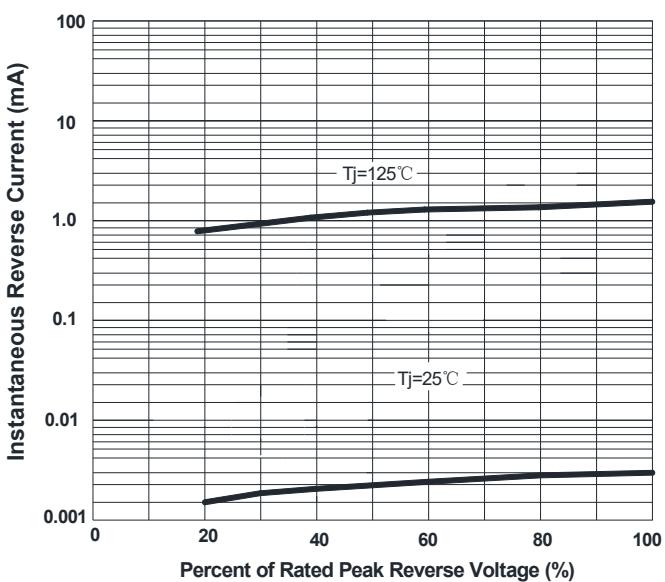
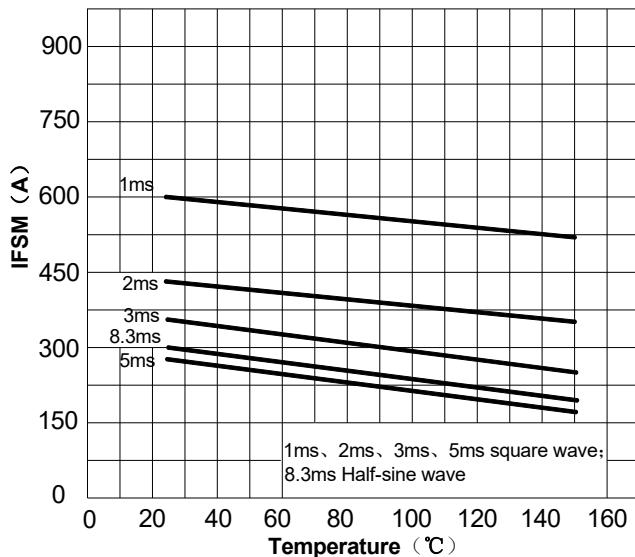
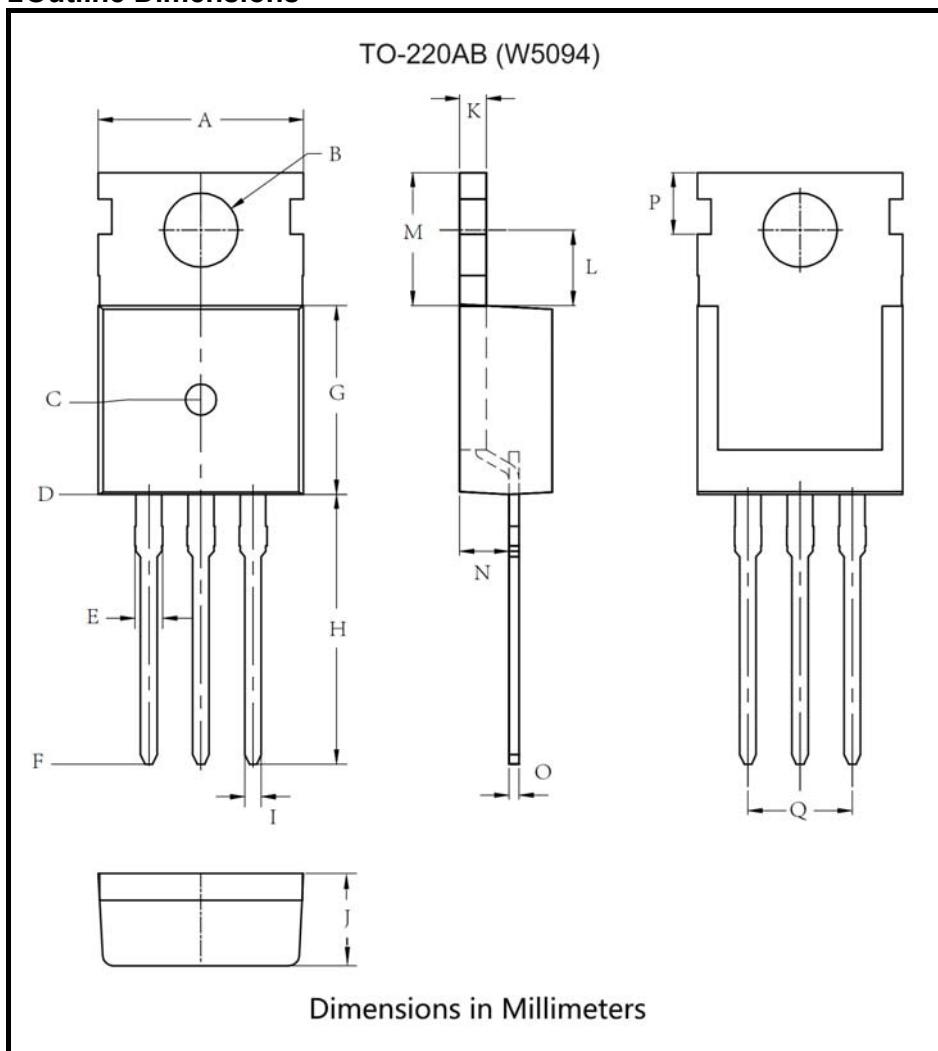


FIG.5: Maximum Non-Repetitive Peak Forward



### ■Outline Dimensions



TO-220AB (W5094)		
Dim	Min	Max
A	9.9	10.1
B	TYP 3.6	
C	8.06	8.46
D	12.67	13.07
E	1.28	1.42
F	25.7	26.3
G	9	9.4
H	12.93	13.33
I	TYP 0.8	
J	4.3	4.7
K	1.285	1.315
L	3.47	3.87
M	6.27	6.67
N	2.2	2.6
O	0.485	0.515
P	2.8	3.2
Q	TYP 5.08	



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